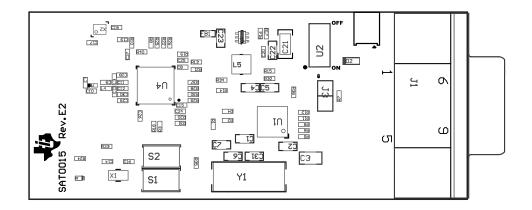
ZZ2 • These assemblies are ESD sensitive, ESD precautions shall be observed.

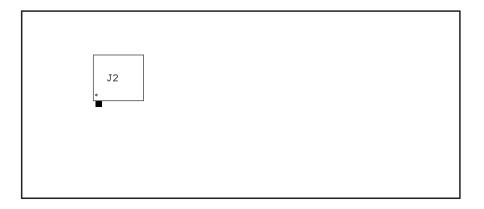
ZZ3 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: SATOO15	REV: E2	SUN REV:	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 1/21/2	014 4:15:21	PM	TEXAS INSTRUMENTS



Bottom Overlay

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